

SKiiP 24NAB12T4V4

Features

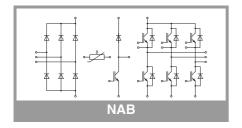
- Trench 4 IGBTs
- Robust and soft freewheeling diodes in CAL technology
- Highly reliable spring contacts for electrical connections
- UL recognised: File no. E63532

Typical Applications*

- Inverter up to 22 kVA
- Typical motor power 11 kW

- Max. case temperature limited to T_C=125°C
- Product reliability results valid for T_j≤150°C (recommended T_{j,op}=-40...+150°C)
- Please refer to MiniSKiiP "Technical Explanations" and "Mounting Instructions" for further information
- No functional isolation between temperature sensor and "-DC/V" and "-DC/W"
- Chopper is limited to I_{t(RMS)} =20A (one spring only)
- All graphs are referring to inverter/ rectifier part

Absolut	e Maximum Ratings	3		
Symbol	Conditions		Values	Unit
Inverter	- IGBT			•
V_{CES}	T _j = 25 °C		1200	V
Ic	λ _{paste} =0.8 W/(mK)	T _s = 25 °C	48	Α
	T _j = 175 °C	T _s = 70 °C	39	Α
I _C	λ _{paste} =2.5 W/(mK)	T _s = 25 °C	53	Α
	T _j = 175 °C	T _s = 70 °C	44	Α
I _{Cnom}			35	Α
I _{CRM}	$I_{CRM} = 3 \times I_{Cnom}$		105	Α
V_{GES}			-20 20	V
t _{psc}	$V_{CC} = 800 \text{ V}$ $V_{GE} \le 15 \text{ V}$ $V_{CES} \le 1200 \text{ V}$	T _j = 150 °C	10	μѕ
Tj			-40 175	°C
Chopper	r - IGBT			
V_{CES}	T _j = 25 °C		1200	V
Ic	λ_{paste} =0.8 W/(mK)	T _s = 25 °C	39	Α
	T _j = 175 °C	T _s = 70 °C	32	Α
Ic	λ _{paste} =2.5 W/(mK)	T _s = 25 °C	43	Α
	T _j = 175 °C	T _s = 70 °C	35	Α
I _{Cnom}			25	Α
I _{CRM}	$I_{CRM} = 3 \times I_{Cnom}$		75	Α
V_{GES}			-20 20	V
t _{psc}	$V_{CC} = 800 \text{ V}$ $V_{GE} \le 15 \text{ V}$ $V_{CES} \le 1200 \text{ V}$	T _j = 150 °C	10	μs
T _j			-40 175	°C
Inverse -	- Diode			•
V_{RRM}	T _j = 25 °C		1200	V
l _F	λ_{paste} =0.8 W/(mK) T _j = 175 °C	T _s = 25 °C	40	Α
		T _s = 70 °C	32	Α
I _F	$\lambda_{paste}=2.5 \text{ W/(mK)}$	T _s = 25 °C	44	Α
	T _j = 175 °C	T _s = 70 °C	35	Α
I _{Fnom}			35	Α
I _{FRM}	I _{FRM} = 2 x I _{Fnom}		70	Α
I _{FSM}	$t_p = 10 \text{ ms, sin } 180^\circ$	°, T _j = 150 °C	170	Α
Tj			-40 175	°C
Freewhe	eling - Diode		•	
V_{RRM}	T _j = 25 °C		1200	V
I _F	λ _{paste} =0.8 W/(mK)	T _s = 25 °C	33	Α
	T _j = 175 °C	T _s = 70 °C	27	Α
IF	λ_{paste} =2.5 W/(mK)	T _s = 25 °C	36	Α
	T _j = 175 °C		29	Α
I _{Fnom}		•	25	Α
I _{FRM}	I _{FRM} = 2 x I _{Fnom}		50	Α
I _{FSM}	$t_p = 10 \text{ ms, sin } 180^\circ$	°, T _j = 150 °C	100	Α
	<u> </u>		-40 175	°C





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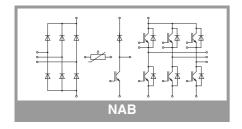
Typical Applications*

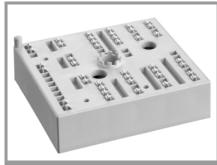
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Absolute	Maximum Ratings	5		
Symbol	Conditions		Values	Unit
Rectifier -	Diode			•
V_{RRM}	T _j = 25 °C		1600	V
l _F	λ _{paste} =0.8 W/(mK)	T _s = 25 °C	52	Α
	T _j = 150 °C	T _s = 70 °C	39	Α
l _F	λ _{paste} =2.5 W/(mK)	T _s = 25 °C	57	Α
	T _j = 150 °C	T _s = 70 °C	43	Α
I _{Fnom}			13	Α
I _{FSM}	10 ms	T _j = 25 °C	370	Α
	sin 180°	T _j = 150 °C	270	Α
I ² t	10 ms	T _j = 25 °C	685	A ² s
	sin 180°	T _j = 150 °C	365	A ² s
Tj			-40 150	°C
Module				
I _{t(RMS)}	T _{terminal} = 80 °C, 20	A per spring	40	Α
T _{stg}			-40 125	°C
V _{isol}	AC sinus 50 Hz, 1 min		2500	V

Characteristics							
Symbol	Conditions		min.	typ.	max.	Unit	
Inverter -	IGBT					•	
V _{CE(sat)}	$I_{C} = 35 \text{ A}$	T _j = 25 °C		1.85	2.10	V	
	V _{GE} = 15 V chiplevel	T _j = 150 °C		2.25	2.45	V	
V_{CE0}	chiplevel	T _j = 25 °C		0.80	0.90	V	
	Chipievei	T _j = 150 °C		0.70	0.80	V	
r_{CE}	$V_{GE} = 15 \text{ V}$	T _j = 25 °C		30	34	mΩ	
	chiplevel	T _j = 150 °C		44	47	$m\Omega$	
$V_{\text{GE(th)}}$	$V_{GE} = V_{CE} V$, $I_C = 1.2 \text{ mA}$		5	5.8	6.5	V	
I _{CES}	$V_{GE} = 0 \text{ V}, V_{CE} = 12$	200 V, T _j = 25 °C		0.1	0.3	mA	
C _{ies}	V 05 V	f = 1 MHz		1.95		nF	
Coes	$V_{CE} = 25 \text{ V}$ $V_{GE} = 0 \text{ V}$	f = 1 MHz		0.16		nF	
C _{res}		f = 1 MHz		0.12		nF	
Q _G	V _{GE} = - 8 V+ 15 V			200		nC	
R _{Gint}	T _j = 25 °C			0		Ω	
t _{d(on)}	$V_{CC} = 600 \text{ V}$	T _j = 150 °C		30		ns	
t _r	I _C = 35 A	T _j = 150 °C		35		ns	
E _{on}		T _j = 150 °C		4.3		mJ	
t _{d(off)}		T _j = 150 °C		300		ns	
t _f		T _j = 150 °C		55		ns	
E _{off}	V _{GE} = +15/-15 V	T _j = 150 °C		3.25		mJ	
R _{th(j-s)}	per IGBT, λ _{paste} =0.8 W/(mK)			1		K/W	
R _{th(j-s)}	per IGBT, λ _{paste} =2.5 W/(mK)			0.82		K/W	





MiniSKiiP® 2

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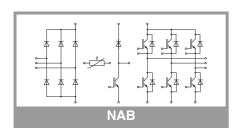
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- All graphs are referring to inverter/ rectifier part

Characte	eristics					
Symbol	Conditions		min.	typ.	max.	Unit
Chopper						
V _{CE(sat)}	I _C = 25 A	T _i = 25 °C		1.85	2.10	V
0 2(000)	V _{GE} = 15 V	T _i = 150 °C		2.25	2.45	V
W	chiplevel	T _i = 25 °C				V
V _{CE0}	chiplevel	T _i = 25 °C		0.80	0.90	V
r	V 15 V	T _i = 150 °C		42	48	mΩ
r _{CE}	V _{GE} = 15 V chiplevel	T _i = 150 °C		62	66	mΩ
$V_{GE(th)}$	$V_{GE} = V_{CE} V, I_C = 0.$,	5	5.8	6.5	V
I _{CES}	$V_{GE} = 0 \text{ V}, V_{CE} = 12$			0.1	0.3	mA
Q _G	V _{GE} = - 8 V+ 15 V	•		142		nC
R _{Gint}	T _i = 25 °C			0		Ω
t _{d(on)}	V _{CC} = 600 V	T _i = 150 °C		12		ns
t _r	I _C = 35 A	T _i = 150 °C		55		ns
E _{on}	$R_{G \text{ on}} = 18 \Omega$ $R_{G \text{ off}} = 18 \Omega$	T _i = 150 °C		4.5		mJ
t _{d(off)}	$di/dt_{on} = 710 \text{ A/}\mu\text{s}$	T _i = 150 °C		300		ns
t _f	$di/dt_{off} = 400 \text{ A/}\mu\text{s}$	T _j = 150 °C		72		ns
E _{off}	V _{GE} = +15/-15 V	T _j = 150 °C		3.9		mJ
R _{th(j-s)}	per IGBT, λ _{paste} =0.8	 3 W/(mK)		1.1		K/W
R _{th(j-s)}	per IGBT, λ _{paste} =2.5 W/(mK)			0.92		K/W
Inverse -	Diode		I			1
$V_F = V_{EC}$	I _F = 35 A	T _i = 25 °C		2.30	2.62	٧
	V _{GE} = 0 V	T _i = 150 °C		2.29	2.62	V
V _{F0}	chiplevel	T _i = 25 °C		1.30	1.50	V
• 10	chiplevel	T _i = 150 °C		0.90	1.10	V
r _F		T _i = 25 °C		29	32	mΩ
<u>'</u>	chiplevel	T _i = 150 °C		40	43	mΩ
I _{RRM}	I _F = 35 A	T _i = 150 °C		34		Α
Q _{rr}	$di/dt_{off} = 1250 \text{ A/}\mu\text{s}$	T _i = 150 °C		5.6		μC
E _{rr}	$V_{GE} = -15 \text{ V}$ $V_{CC} = 600 \text{ V}$	T _i = 150 °C		2.4		mJ
R _{th(j-s)}	per Diode, $\lambda_{paste}=0$.	.8 W/(mK)		1.4		K/W
R _{th(j-s)}	per Diode, λ _{paste} =2.			1.2		K/W
	eling - Diode	. ,				1
$V_F = V_{EC}$	I _F = 25 A	T _i = 25 °C		2.41	2.74	V
-1 -10	V _{GE} = 0 V	T _i = 150 °C		2.45	2.79	V
.,	chiplevel					
V _{F0}	chiplevel	T _j = 25 °C		1.30	1.50	V
<u> </u>		$T_j = 150 ^{\circ}\text{C}$ $T_i = 25 ^{\circ}\text{C}$		0.90	1.10	V
r _F	chiplevel	T _i = 25 °C		62	50	mΩ
I _{DDL} .	I _F = 25 A	T _i = 150 °C		62 30	68	mΩ
Q _{rr}	di/dt _{off} = 1160 A/μs	T _i = 150 °C		5		μC
	$V_{GE} = -15 \text{ V}$	T _i = 150 °C		2		1 .
Err	$V_{CC} = 600 \text{ V}$	<u> </u>				mJ
R _{th(j-s)}	per Diode, $\lambda_{paste}=0$			1.44		K/W K/W
R _{th(j-s)}	per Diode, $\lambda_{paste}=2$.	.o vv/(IIIIx)		1.22		IV/VV





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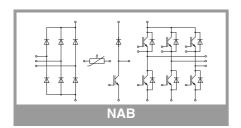
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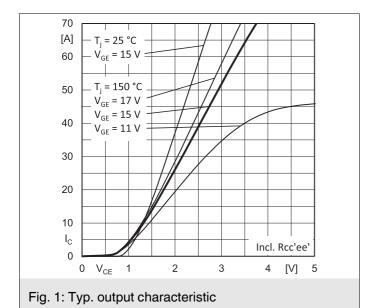
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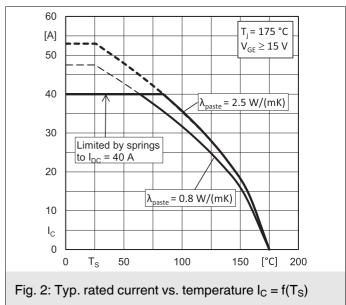
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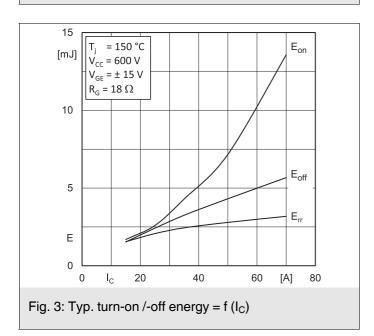
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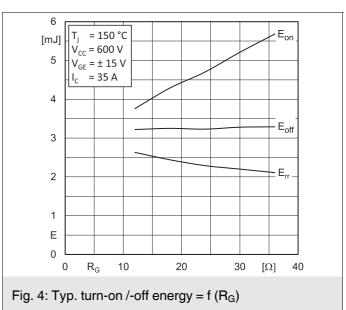
Characteristics							
Symbol	Conditions		min.	typ.	max.	Unit	
Rectifier -	Diode						
$V_F = V_{EC}$	I _F = 13 A	T _j = 25 °C		1.00	1.21	V	
	V _{GE} = 0 V chiplevel	T _j = 125 °C		0.90	1.10	V	
V_{F0}	chiplevel	T _j = 25 °C		0.88	0.98	V	
	ompiever	T _j = 125 °C		0.73	0.83	V	
r _F	chiplevel	T _j = 25 °C		9.2	18	mΩ	
	ompiever	T _j = 125 °C		13	21	mΩ	
R _{th(j-s)}	per Diode, λ _{paste} =0.8 W/(mK)			1.25		K/W	
R _{th(j-s)}	per Diode, λ _{paste} =2.5 W/(mK)			1.1		K/W	
Module							
Ms	to heat sink		2		2.5	Nm	
w				55		g	
L _{CE}			-		nΗ		
Temperature Sensor							
R ₁₀₀	T _r = 100 °C			1670 ± 3%		Ω	
R(T)	R(T)=1000Ω[1+A(T-25°C)+B(T-25°C) ²], A = 7.635*10 ⁻³ °C ⁻¹ , B = 1.731*10 ⁻⁵ °C ⁻²						

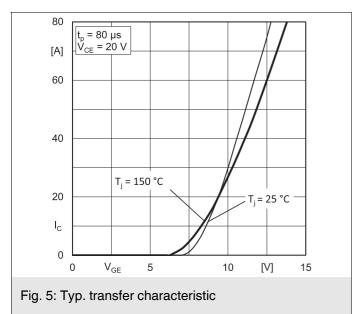


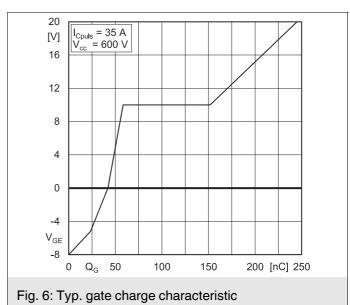


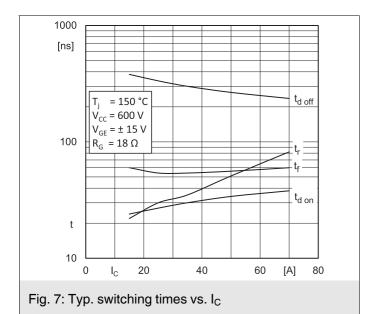


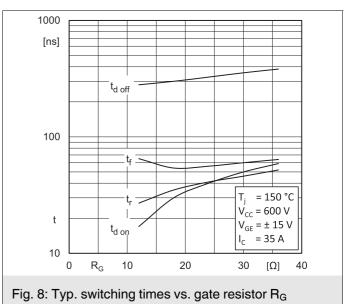


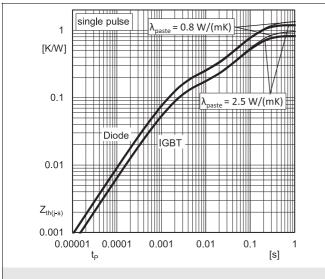




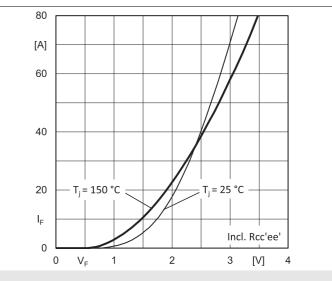


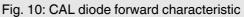












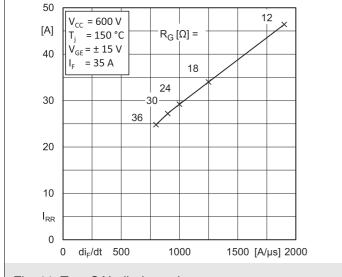


Fig. 11: Typ. CAL diode peak reverse recovery current

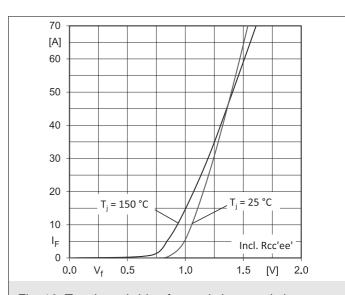
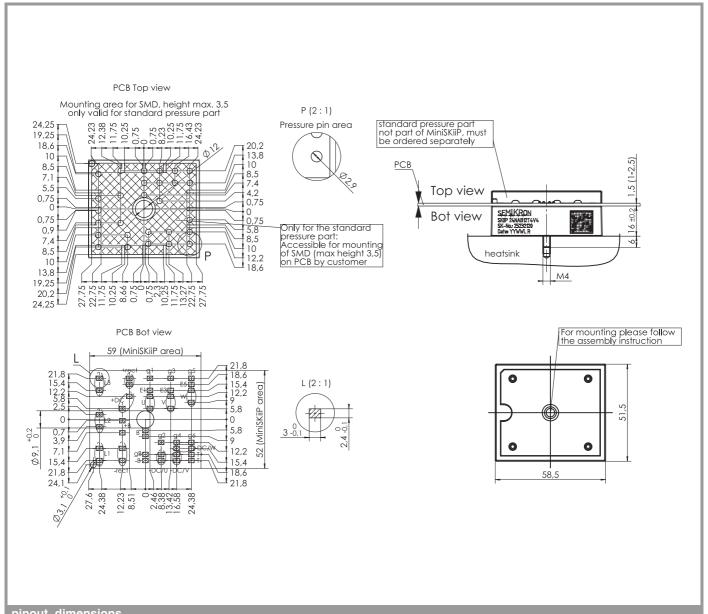
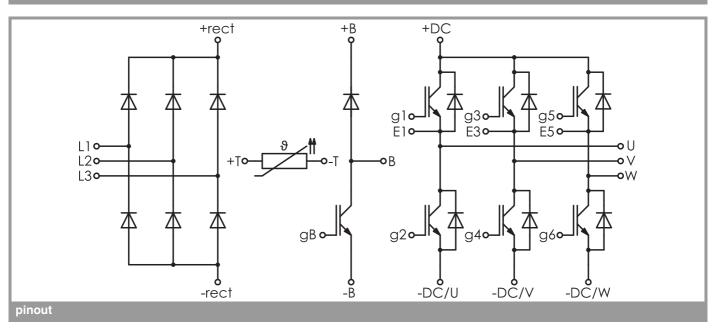


Fig. 12: Typ. input bridge forward characteristic



pinout, dimensions



This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, chapter IX.

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